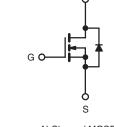
Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	100			
R _{DS(on)} (Ω)	$V_{GS} = 5.0 V$	0.54		
Q _g (Max.) (nC)	6.1			
Q _{gs} (nC)	2.6			
Q _{gd} (nC)	3.3			
Configuration	Sing	le		





N-Channel MOSFET

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- Surface Mount
- Available in Tape and Reel
- Dynamic dV/dt Rating
- Repetitive Avalanche Rated
- Logic-Level Gate Drive
- $R_{DS(on)}$ Specified at $V_{GS} = 4 V$ and 5 V
- Fast Switching
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effictiveness.

The SOT-223 package is designed for surface-mounting using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performace due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION				
Package	SOT-223	SOT-223		
Lead (Pb)-free and Halogen-free	SiHLL110-GE3	-		
Lead (Pb)-free	IRLL110PbF	IRLL110TRPbF ^a		
Lead (PD)-liee	SiHLL110-E3	SiHLL110T-E3ª		
SnPb	IRLL110	IRLL110TR ^a		
SIED	SiHLL110	SiHLL110T ^a		
Note	· · · · · ·	· · · · · · · · · · · · · · · · · · ·		

a. See device orientation.

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	100	v	
Gate-Source Voltage			V _{GS}	± 10	v	
Continuous Drain Current	V _{GS} at 5.0 V	V_{GS} at 5.0 V $\begin{array}{c} T_C = 25 \text{ °C} \\ T_C = 100 \text{ °C} \end{array}$	la la	1.5		
$V_{GS} \approx 3.0 \text{ V}$ $T_{C} = 100 \text{ °C}$		I _D	0.93	A		
Pulsed Drain Current ^a			I _{DM}	12		
Linear Derating Factor				0.025	W/°C	
Linear Derating Factor (PCB Mount) ^e				0.017	VV/ C	
Single Pulse Avalanche Energy ^b			E _{AS}	50	mJ	
Repetitive Avalanche Current ^a			I _{AR}	1.5	A	
Repetitive Avalanche Energy ^a			E _{AR}	0.31	mJ	
Maximum Power Dissipation T _C = 25 °C			Р	3.1	w	
Maximum Power Dissipation (PCB Mount) ^e $T_A = 25 \text{ °C}$			P _D	2.0	- vv	
Peak Diode Recovery dV/dt ^c			dV/dt	5.5	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 1	0 s	0	300 ^d		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 25 mH, $R_g = 25 \Omega$, $I_{AS} = 1.5 \text{ A}$ (see fig. 12). c. $I_{SD} \le 5.6 \text{ A}$, dl/dt $\le 75 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$. d. 1.6 mm from case.

When mounted on 1" square PCB (FR-4 or G-10 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply

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COMPLIANT

HALOGEN

FREE

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	60	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		- -					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$	Reference	e to 25 °C, I _D = 1 mA	-	0.12	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	- V _{GS} , I _D = 250 μA	1.0	-	2.0	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 10 V	-	-	± 100	nA
Zara Cata Valtaga Drain Current	1	V _{DS} =	= 100 V, V _{GS} = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 125 °C		-	250	μA
		$V_{GS} = 5.0 V$	I _D = 0.90 A ^b	-	-	0.54	0
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 4.0 V$	I _D = 0.75 A	-	-	0.76	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	25 V, I _D = 0.90 A	0.57	-	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$	-	250	-	
Output Capacitance	C _{oss}		$V_{DS} = 25 V,$	-	80	-	pF
Reverse Transfer Capacitance	C _{rss}	f = 1.	0 MHz, see fig. 5	-	15	-	
Total Gate Charge	Qg			-	-	6.1	
Gate-Source Charge	Q _{gs}	V _{GS} = 5.0 V	$I_D = 5.6 \text{ A}, V_{DS} = 80 \text{ V},$ see fig. 6 and 13 ^b	-	-	2.6	nC
Gate-Drain Charge	Q _{gd}		See lig. 6 and 16	-	-	3.3	
Turn-On Delay Time	t _{d(on)}			-	9.3	-	
Rise Time	t _r	- V_D =	= 50 V, I _D = 5.6 A,	-	47	-	
Turn-Off Delay Time	t _{d(off)}	$R_{g} = 12 \Omega, R_{D} = 8.4 \Omega$ - 16 -		ns			
Fall Time	t _f			-	18	-	
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		-	4.0	-	
Internal Source Inductance	L _S	package and die contact	center of	-	6.0	-	nH
Drain-Source Body Diode Characteristic	s	-					
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	1.5	Α
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction		-	-	12	
Body Diode Voltage	V_{SD}	T _J = 25 °C	, I _S = 1.5 A, V _{GS} = 0 V ^b	-	-	2.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C 1	E C A dl/dt 100 A (b	-	110	130	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$I_{\rm J} = 25 {}^{-}{\rm C}, I_{\rm F}$	= 5.6 A, dl/dt = 100 A/µs ^b	-	0.50	0.65	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	rn-on time is negligible (turn	on is dor	ninated b	v Ls and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

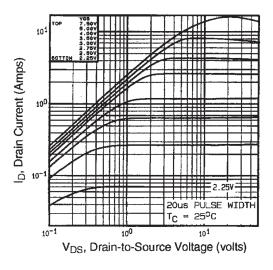


Fig. 1 - Typical Output Characteristics

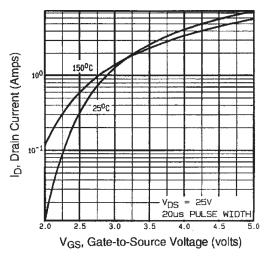


Fig. 3 - Typical Transfer Characteristics

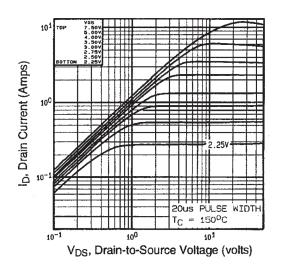


Fig. 2 - Typical Output Characteristics

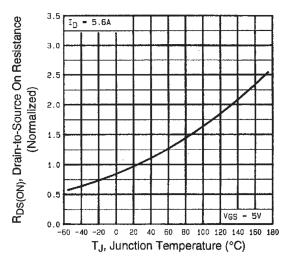


Fig. 4 - Normalized On-Resistance vs. Temperature

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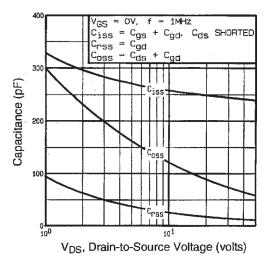
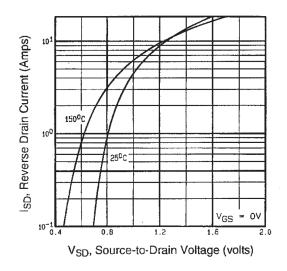


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





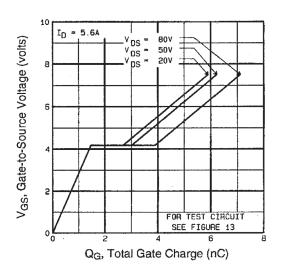


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

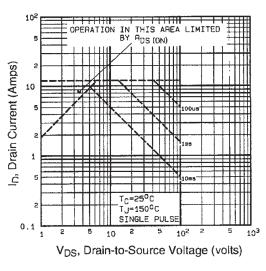


Fig. 8 - Maximum Safe Operating Area



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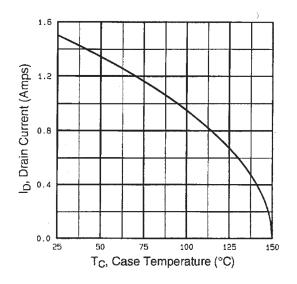


Fig. 9 - Maximum Drain Current vs. Case Temperature

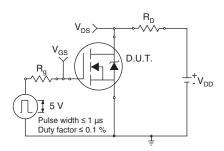


Fig. 10a - Switching Time Test Circuit

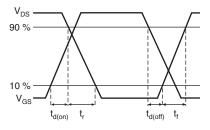


Fig. 10b - Switching Time Waveforms

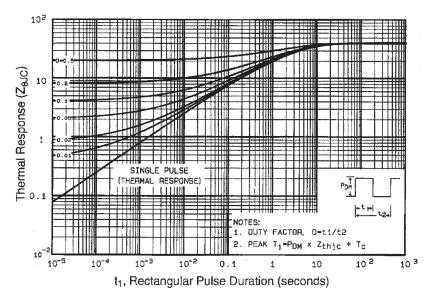


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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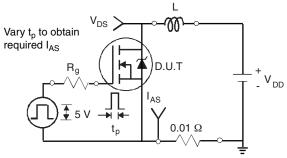


Fig. 12a - Unclamped Inductive Test Circuit

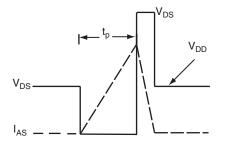


Fig. 12b - Unclamped Inductive Waveforms

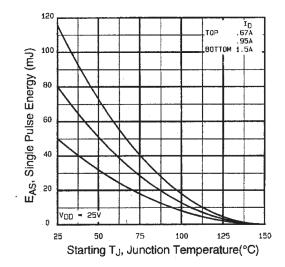
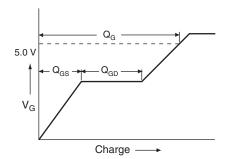


Fig. 12c - Maximum Avalanche Energy vs. Drain Current





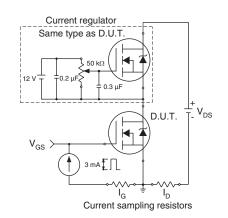
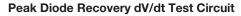


Fig. 13b - Gate Charge Test Circuit

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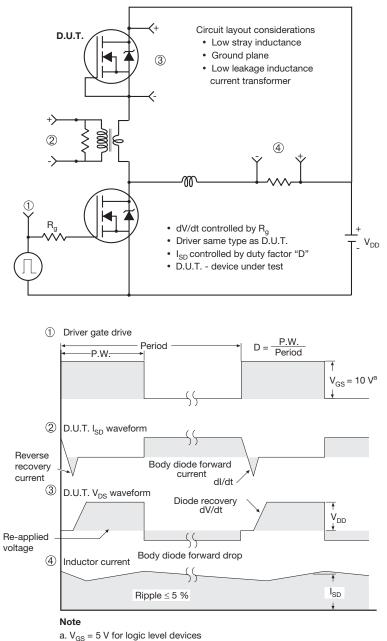


Fig. 14 - For N-Channel

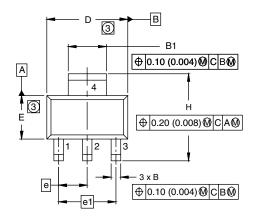
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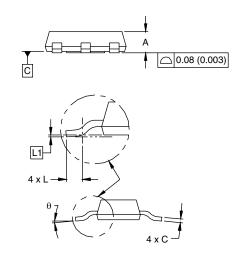
Document Number: 91320 S10-1257-Rev. C, 31-May-10



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SOT-223 (HIGH VOLTAGE)





	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
А	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905 BSC		
e1	4.60	4.60 BSC		BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	-	
L1	0.061 BSC		0.002	4 BSC	
θ	-	10'	-	10'	

Notes

1. Dimensioning and tolerancing per ASME Y14.5M-1994.

2. Dimensions are shown in millimeters (inches).

3. Dimension do not include mold flash.

4. Outline conforms to JEDEC outline TO-261AA.



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